Bluetooth Module Datasheet

Model: SJR-BTM324

Version: V1.3

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List of Contents

1 Introduction	3
2 Key Features	3
3 Applications	4
4 Block Diagram	4
5 General specifications	4
6 Module Package Information	5
6.1 Pinout Diagram and package dimensions	5
6.2 Module Pin descriptions	6
7 Electrical Characteristics	10
7.1 Absolute Maximum Ratings	10
7.2 Recommended Operating Conditions	10
8 Recommended reflow temperature profile	11

1 Introduction

Sky Jiarun Technologies introduces the pioneer of the Bluetooth 5.1 modules SJR-BTM324 which is a high performance, cost effective, low power and compact solution. The Bluetooth module provides a complete 2.4GHz Bluetooth system based on the QCC3024 BGA chipset which is a single chip radio and baseband IC for Bluetooth 2.4GHz systems. This module is fully qualified single-chip dual mode Bluetooth@v5.1 system.

2 Key Features

BTM324(QCC3024) Features

- Qualified to Bluetooth® v5.1 specification
- 120 MHz Qualcomm® Kalimba™ audio DSPs
- 32 MHz Developer Processor for applications
- Firmware Processor for system
- Flexible QSPI flash programmable platform
- Advanced audio algorithms
- High-performance 24-bit stereo audio interface
- Digital and analog microphone interfaces
- SBC and AAC audio codecs support
- Serial interfaces: UART, Bit Serializer (I² C/SPI),USB 2.0
- Integrated PMU: Dual SMPS for system/digital circuits, Integrated Li-ion battery charger

Application subsystem

- Dual core application subsystem 32 MHz operation
- 32-bit Firmware Processor:
 - Reserved for system use
 - Runs Bluetooth upper stack, profiles, house-keeping code
- 32-bit Developer Processor:Runs developer applications
- Both cores execute code from external flash memory using QSPI clocked at 32 MHz
- On-chip caches per core allow for optimized performance and power consumption

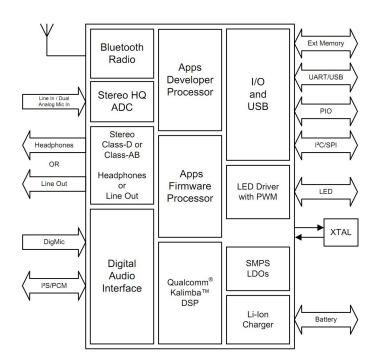
Bluetooth subsystem

- Qualified to Bluetooth v5.1 specification including 2 Mbps Bluetooth low energy (Production parts)
- Single ended antenna connection with on-chip balun and Tx/Rx switch
- Bluetooth, Bluetooth low energy, and mixed topologies supported
- Class 1 support

3 Applications

- Wired/wireless stereo headsets/headphones
- Qualcomm TrueWireless™ stereo earbuds
- USB to Bluetooth dongle

4 Block Diagram

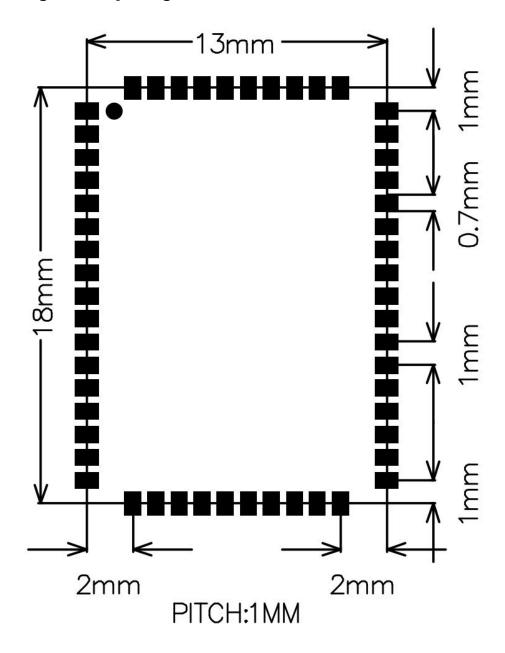


5 General specifications

Model Name	SJR-BTM324
Product Description	Bluetooth 5.1 Class1.5 Module
Bluetooth Standard	Bluetooth 5.1
Chipset	QCC3024 BGA
Dimension	13mm x 18mm x 2.8mm
Operating Conditions	
Voltage	2.8~4.3V
Temperature	-40∼+85℃
Storage Temperature	-40∼+85℃
Electrical Specifications	
Frequency Range	2402~2480MHz
Maximum RF Transmit Power	9dBm
π /4 DQPSK Receive Sensitivity	-92dBm
8DPSK Receive Sensitivity	-85dBm

6 Module Package Information

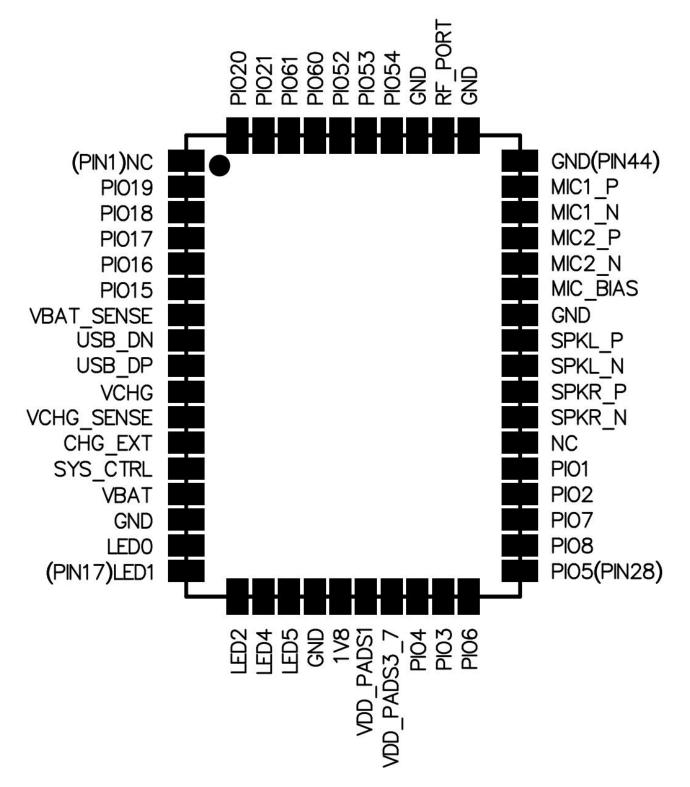
6.1 Pinout Diagram and package dimensions



Unit: MM

Recommended PCB layout footprint

6.2 Module Pin descriptions



Pin#	Pin Name	Pin type	Description
1	NC	NC	NC
		Digital: Bidirectional with	Programmable I/O line 19.
2	PIO[19]	programmable strength internal	Alternative function:
		pull- up/pull-down	PCM_DIN[0]
3	PIO[18]	Digital: Bidirectional with	Programmable I/O line 18.

		programmable strength internal	Alternative function:
		pull- up/pull-down	PCM_DOUT[0]
		Digital: Bidirectional with	Programmable I/O line 17.
4	PIO[17]	programmable strength internal	Alternative function:
		pull- up/pull-down	PCM_SYNC
		Digital: Bidirectional with	Programmable I/O line 16.
5	PIO[16]	programmable strength internal	Alternative function:
		pull- up/pull-down	PCM CLK
		Digital: Bidirectional with	Programmable I/O line 15.
6	PIO[15]	programmable strength internal	Alternative function:
		pull- up/pull-down	MCLK_OUT
7	VBAT_SENSE	Analog	Battery voltage sense input.
	_		USB Full Speed device D- I/O. IEC-61000-4-2
8	USB_DN	Digital	(device level) ESD Protection
			USB Full Speed device D+ I/O. IEC-61000-4-2
9	USB_DP	Digital	(device level) ESD Protection
10	VCHG	Supply	Charger input to Bypass regulator.
		117	Charger input sense pin after external mode
			sense-resistor. High impedance.
11	VCHG_SENSE	Analog	5 1
			NOTE If using internal charger or no charger,
			connect VCHG_SENSE direct to VCHG.
			External charger transistor current control. Connect
12	CHG_EXT	Analog	to base of external charger transistor as per
			application schematic.
			Typically connected to an ON/OFF push button.
			Boots device in response to a button press when
			power is still present from battery and/or charger but
12	eve ctpl	Digital input	software has placed the device in the OFF or
13	SYS_CTRL	Digital input	DORMANT state. Additionally useable as a digital
			input in normal operation. No pull.
			Additional function:
			PIO[0] input only
14	VBAT	Supply	Battery voltage input.
15	GND	Ground	Ground
16	AIO[0]/LED[0]	Analog or digital input/ open drain	General-purpose analog/digital input or open drain
	7110[0],225[0]	output.	LED output.
17 AIO	AIO[1]/LED[1]	Analog or digital input/ open drain	General-purpose analog/digital input or open drain
	,	output.	LED output.
18 AI	AIO[2]/LED[2]	Analog or digital input/ open drain	General-purpose analog/digital input or open drain
	, > [=], === [=]	output.	LED output.
19 A	AIO[4]/LED[4]	Analog or digital input/ open drain	General-purpose analog/digital input or open drain
	~[.]	output.	LED output.
20 AIO[5]/LED	AIO[5]/LED[5]	Analog or digital input/ open drain	General-purpose analog/digital input or open drain
, woldherpfol		output.	LED output.

21	GND	Ground	Ground
22	1V8	Supply	1.8V voltage output.
23	VDD_PADS1	Supply	1.8 V/3.3 V PIO supply.
24	VDD_PADS3_7	Supply	1.8 V/3.3 V PIO supply.
	VBB_I	Digital: Bidirectional with	Programmable I/O line 4.
25	PIO[4]	programmable strength internal	Alternative function:
		pull- up/pull-down	TBR_MOSI[1]
		Digital: Bidirectional with	Programmable I/O line 3.
26	PIO[3]	programmable strength internal	Alternative function:
	1.10[6]	pull- up/pull-down	TBR_MISO[2]
		Digital: Bidirectional with	Programmable I/O line 6.
27	PIO[6]	programmable strength internal	Alternative function:
	1 10[0]	pull- up/pull-down	TBR_MOSI[0]
		Digital: Bidirectional with	Programmable I/O line 5.
28	PIO[5]	programmable strength internal	Alternative function:
20	1 10[5]	pull- up/pull-down	TBR_MISO[1]
		Digital: Bidirectional with	Programmable I/O line 8.
29	PIO[8]	programmable strength internal	Alternative function:
23	1 10[0]	pull- up/pull-down	TBR_CLK
		Digital: Bidirectional with	Programmable I/O line 7.
30	PIO[7]	programmable strength internal	Alternative function:
30	1 10[7]	pull- up/pull-down	TBR_MISO[0]
		Digital: Bidirectional with	Programmable I/O line 2.
31	PIO[2]	programmable strength internal	Alternative function:
	10[2]	pull- up/pull-down	TBR_MISO[3]
		pan ap/pan acimi	Automatically defaults to RESET# mode when the
		Digital: Bidirectional with	device is unpowered, or in off modes.
32	PIO[1]	programmable strength internal	Reconfigurable as a PIO after boot.
02	FIG[1]	pull- up/pull-down	Alternative function:
		pan ap/pan activi	Programmable I/O line 1
33	NC	NC	NC
			Headphone/speaker differential right output,
			negative.
34	AUDIO_HPR_N/ SPKR_N	Analog	Alternative function:
			Differential right line output, negative
			Headphone/speaker differential right output,
			positive.
35	AUDIO_HPR_P/ SPKR_P	Analog	Alternative function:
			Differential right line output, positive
			Headphone/speaker differential left output,
			negative.
36	AUDIO_HPL_N/ SPKL_N	Analog	Alternative function:
			Differential left line output, negative
			Headphone/speaker differential left output, positive.
37	AUDIO_HPL_P/ SPKL_P	Analog	Alternative function:
			Alternative function.

			Differential left line output, positive	
38	GND	Ground	Ground	
39	AUDIO_MIC_BIAS	Analog	Mic bias output.	
			Microphone differential 2 input, negative.	
40	AUDIO_MIC2_N/ LINEIN_R_N	Analog	Alternative function:	
			Differential audio line input right, negative	
			Microphone differential 2 input, positive.	
41	AUDIO_MIC2_P/ LINEIN_R_P	Analog	Alternative function:	
			Differential audio line input right, positive	
			Microphone differential 1 input, negative.	
42	AUDIO_MIC1_N/ LINEIN_L_N	Analog	Alternative function:	
			Differential audio line input left, negative	
			Microphone differential 1 input, positive.	
43	AUDIO_MIC1_P/ LINEIN_L_P	Analog	Alternative function:	
			Differential audio line input left, positive	
44	GND	Ground	Ground	
45	GND	Ground	Ground	
46	BT_RF	RF	Bluetooth transmit/receive.	
47	GND	Ground	Ground	
		Digital: Bidirectional with	Programmable I/O line 54.	
48	PIO[54]	programmable strength internal	Alternative function:	
		pull- up/pull-down	SDIO_D[0]	
		Digital: Bidirectional with	Programmable I/O line 53.	
49	PIO[53]	programmable strength internal	Alternative function:	
		pull- up/pull-down	SDIO_CMD	
		Digital: Bidirectional with	Programmable I/O line 52.	
50	PIO[52]	programmable strength internal	Alternative function:	
		pull- up/pull-down	SDIO_CLK	
		Digital: Bidirectional with		
51	PIO[60]	programmable strength internal	Programmable I/O line 60.	
		pull- up/pull-down		
		Digital: Bidirectional with		
52	PIO[61]	programmable strength internal	Programmable I/O line 61.	
		pull- up/pull-down		
		Digital: Bidirectional with	Programmable I/O line 21.	
53	PIO[21]	programmable strength internal	Alternative function:	
		pull- up/pull-down	PCM_DOUT[2]	
		Digital: Bidirectional with	Programmable I/O line 20.	
54	PIO[20]	programmable strength internal	Alternative function:	
		pull- up/pull-down	PCM_DOUT[1]	

7 Electrical Characteristics

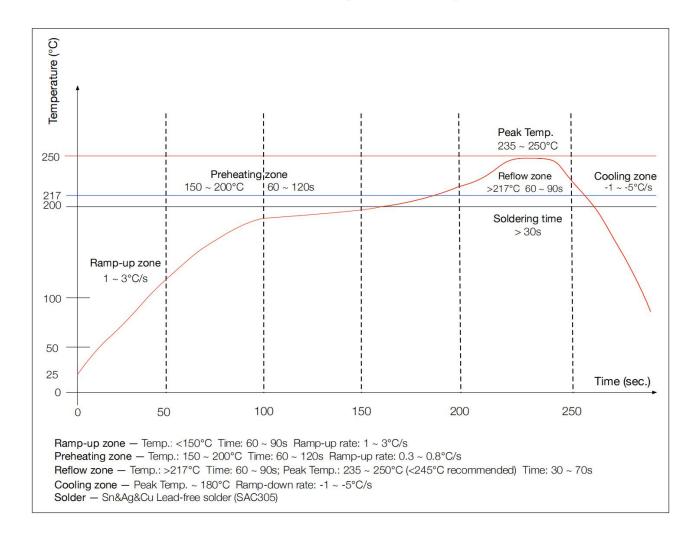
7.1 Absolute Maximum Ratings

Rating	Minimum	Maximum
Storage temperature	-40 ℃	+85℃

7.2 Recommended Operating Conditions

Operating Condition	Minimum	Maximum
Operating temperature range	-40 ℃	+85°C
Supply voltage: VBAT	+2.8V	+4.3V

8 Recommended reflow temperature profile



The module Must go through 125 $^{\circ}$ C baking for at least 9 hours before SMT AND IR reflow process!

若拆封后未立即上线,天嘉润科技建议让下次上线前务必以 125℃烘烤 9 小时以上!

Record of Changes

Data	Revision	Description
2018-08-10	V1.0	Original publication of this document.
2018-10-12	V1.1	Fix PIN definition.
2020-04-23	V1.2	Fix PIN definition.
2021-11-21	V1.3	Updata bluetooth 5.1 version and temperature.

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